# **MAX30101 Evaluation System**

### **General Description**

The MAX30101 evaluation kit (EV kit) provides a proven design to evaluate the MAX30101 integrated pulse-oximetry and heart-rate monitor integrated circuit (IC). The EV kit consist of two boards. USBOSMB is the mother board and MAX30101DBEVKIT is the daughter board that includes the MAX30101 and an accelerometer. The EV kit is powered using the USB supply to generate +1.8V for the sensor and +4.5V for the internal LEDs of the MAX30101, and +3.3V for the accelerometer.

The EV kit comes with a MAX30101EFD+ installed in a 14-pin OESIP package.

#### **Features**

- Real-Time Monitoring
- Flexible PCB Design
- USB-Powered
- On-Board Accelerometer
- Proven PCB Layout
- Fully Assembled and Tested
- Windows® 7-, and Windows 8/8.1-Compatible Software

Ordering Information appears at end of data sheet.

#### **Quick Start**

#### **Required Equipment**

 MAX30101 accelerometer EV kit (MAX30101DBEVKIT#, USBOSMB#, 10-pin FFC cable, and micro-USB cable included)

**Evaluates: MAX30101** 

Windows PC

**Note:** Text in **bold** refers to items directly from the EV kit software. Text in **bold and underlined** refers to items from the Windows operating system.

#### **Procedure**

The EV kit is fully assembled and tested. Follow the steps below to verify board operation:

- Visit <u>www.maximintegrated.com/evkit-software</u> to download the most recent version of the EV kit software, MAX30101EVKitSetupVx.x.ZIP. Save the EV kit software to a temporary folder and uncompress the ZIP file.
- 2) Open up *MAX30101EVKitSetupVx.x.exe* and follow the instructions from the pop-up windows.
- 3) Insert one end of the ribbon cable to the J3 connector of the USBOSMB and the other end of the ribbon cable to the J1 connector of the MAX30101DBEV-KIT. Make sure that both connectors and blue ends of the ribbon cable is facing the user.
- 4) Connect the USB cable from the PC to the EV kit board. Windows will automatically install all drivers.
- 5) Open the *MAX30101EVKit.exe* and verify that the EV kit is connected by observing the status bar at the lower left corner of the GUI. See Figure 1.
- 6) Press the **Start Monitor** button.
- 7) Place your finger in front of the MAX30101 (U4) of the EV kit and observe the **Measurement** graphs. See Figure 2. Example algorithm 1 and 2 are shown in separate windows (Figure 3 and Figure 4).

Windows is a registered trademark and registered service mark of Microsoft Corporation.



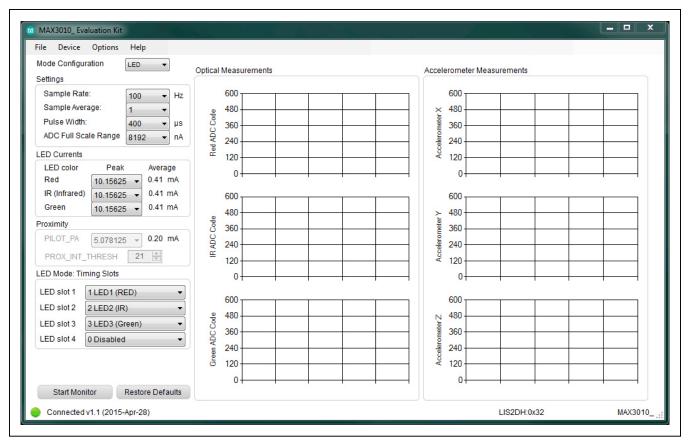


Figure 1. MAX30101 EV Kit Main Window

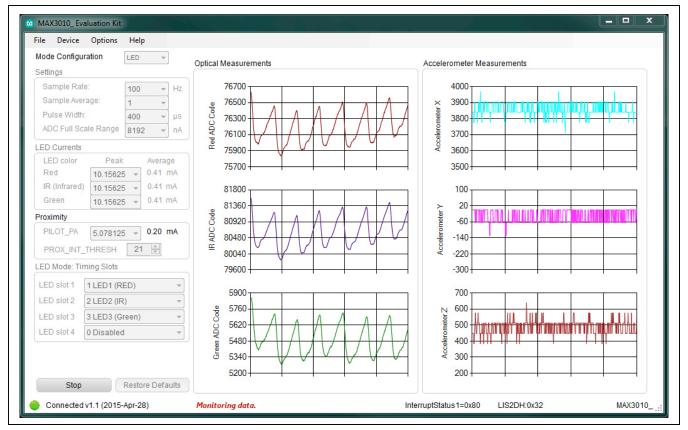


Figure 2. MAX30101 EV Kit Main Window (Sampling Data)



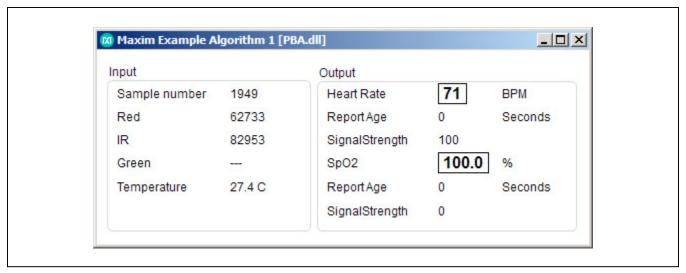


Figure 3. Maxim Example Algorithm 1 Window

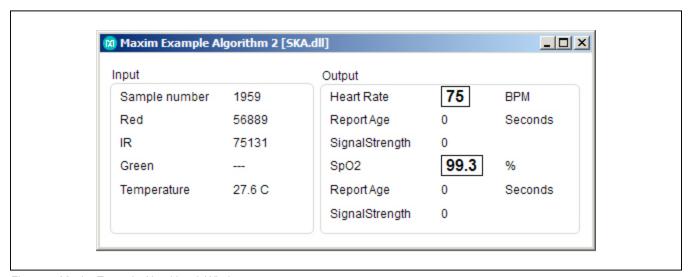


Figure 4. Maxim Example Algorithm 2 Window

# Evaluates: MAX30101

### **Detailed Description of Software**

The main window of the MAX30101 EV kit software displays the mode configuration, settings, LED currents, proximity, timing slots of the LED mode, ADC code measurements, and example algorithms.

#### **Mode Configuration**

The **Mode Configuration** drop-down list allows for three options: HR, SPO2, and LED. When HR is selected, only

red ADC codes are plotted. When SPO2 is selected, only red and IR codes are plotted. When LED is selected, red, IR, and/or green ADC codes are plotted. Figure 5 shows the device configured to LED mode and using all three LEDs: red, IR, and green. Within LED mode, the **Led Mode Timing Slots** groupbox selections allow the user to enable the desired LEDs at each LED slot.



Figure 5. MAX30101 EV Kit Main Window (LED Mode with Green LED)

#### Settings

The **Settings** groupbox consist of controls to the sample rate and average, pulse width, and ADC full-scale range.

The **Sample Rate** drop-down list is adjustable from 50Hz to 400Hz.

The **Sample Average** drop-down list is adjustable from 1 to 32.

The **Pulse Width** dropdown list is adjustable from 50µs to 400µs.

The **ADC Full Scale Range** dropdown list is adjustable from 2048nA to 16384nA.

#### **LED Currents**

Within the **LED Currents** groupbox, the peak currents are adjustable from **0** to **50**mA for each LED. The average current based on the **Pulse Width** and **Sample Rate** is recalculated with each change in peak current.

#### **Proximity**

Under Proximity, **PILOT PA** is adjustable from **0** to **50**mA.

#### **Accelerometer**

The accelerometer provides three degrees of freedom (3DOF). Moving the MAX30101DBEVKIT board will trigger changes in ADC data of the X, Y, and/or Z graphs.

#### **Algorithms**

<u>Figure 3</u> and <u>Figure 4</u> are example algorithms to calculate heart rate and SpO<sub>2</sub>. They are calculated using the raw ADC data from the LEDs.

The two algorithms included with the EV kit are PBA and SKA. They are provided to demonstrate the capability of the product and are not intended for mass production. Here are some significant differences between the two.

PBA looks for zero crossing using slow threshold. The algorithm completes its cycle each sampling point. SKA waits for 3s and then looks for peak detection. The algorithm is processed every 1s, but it requires a more complex math operation. The user needs to present 3s FIFO data to algorithm. Heart rate is from average of 3s of data.

Each of these algorithms has its own advantage. For example, PBA requires much less data space and code space compared to SKA.

ALGORITHM	DELAY	MEMORY	DATA SPACE
PBA	None	5772	870
SKA	3s	31160	52723

#### **Data Logging**

From the menu bar, select **File | Log** and ADC data can be logged to a .csv file with the option of collecting data for a specific time using the **File | Timed Data Collection** selection from **5** to **60 seconds**. Once the desired configuration is set, press the **Start Monitor** button to capture data. The header for each data set includes the settings for sample rate, LED current, pulse width, and the mode. If the file name is not changed, subsequent data collection will append to the existing file and will include a new header.

Evaluates: MAX30101

#### **Options**

From the menu bar, **Options** allows the user to adjust the plot length and the x-axis, hide unused channels, show/hide the algorithm windows, and access registers from a bit level.

## **Detailed Description of Hardware**

The MAX30101 EV kit provides a proven design to evaluate the MAX30101 integrated pulse-oximetry, heart-rate monitor module. The EV kit is powered through the +5V from the USB port to generate the regulated +1.8V to V<sub>DD</sub> supply and +4.5V to the +VLED supply of the MAX30101. Use Table 1 to change the R10 resistor to obtain the desired +VLED supply. The IC U1 of the EV kit is the on-board microcontroller that communicates with the MAX30101 through GPIO for the interrupt signal and I2C interface.

There is also a 3.3V supply on the EV board and is intended for the on-board MCU.

Table 1. Resistor Selection for +VLED Supply

+VLED	R10 (kΩ)
2.5V	14.3
3.3V	23.2
4.0V	31.6
4.5V	36.5*

<sup>\*</sup>Default

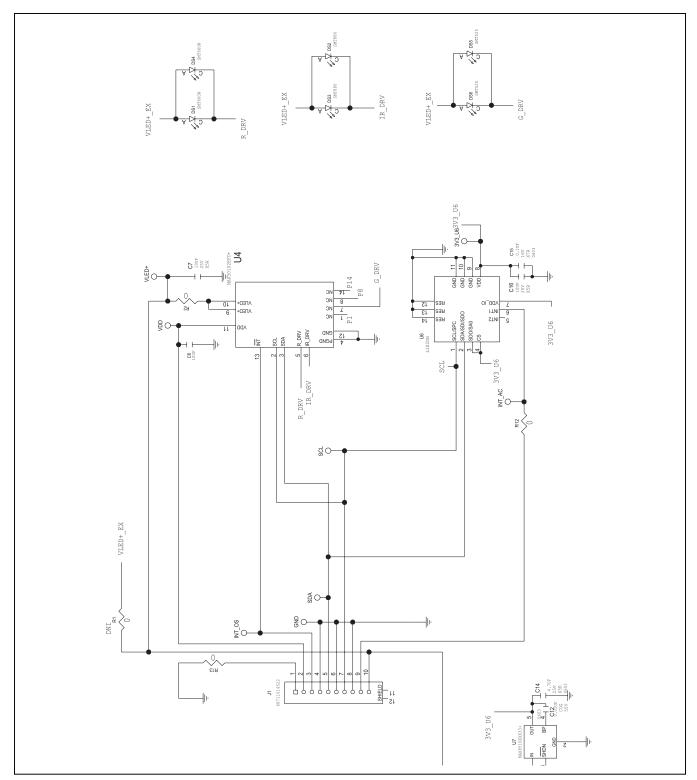


Figure 6. MAX30101 Daughter Board Schematic

# MAX30101 Evaluation System

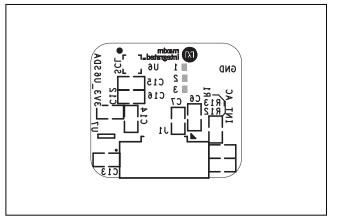
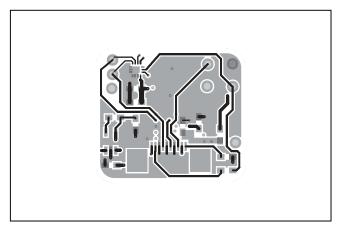


Figure 7. MAX30101 Daughter Board Component Placement Guide—Component Side



Evaluates: MAX30101

Figure 8. MAX30101 Daughter Board PCB Layout—Layer 2

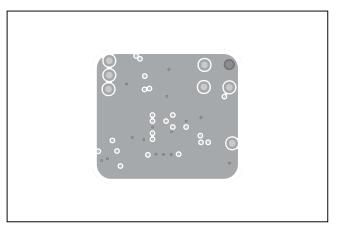


Figure 9. MAX30101 Daughter Board PCB Layout—Layer 3

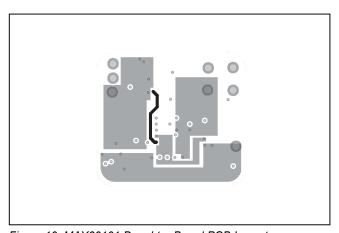


Figure 10. MAX30101 Daughter Board PCB Layout—Component Side

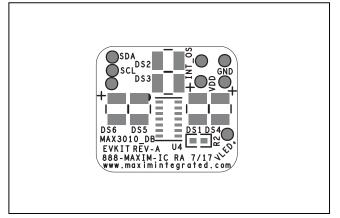


Figure 11. MAX30101 Daughter Board PCB Layout—Solder Side

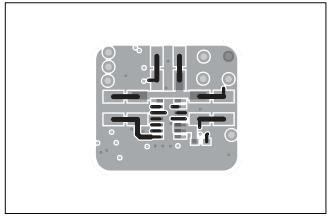


Figure 12. MAX30101 Daughter Board Component Placement Guide—Solder Side

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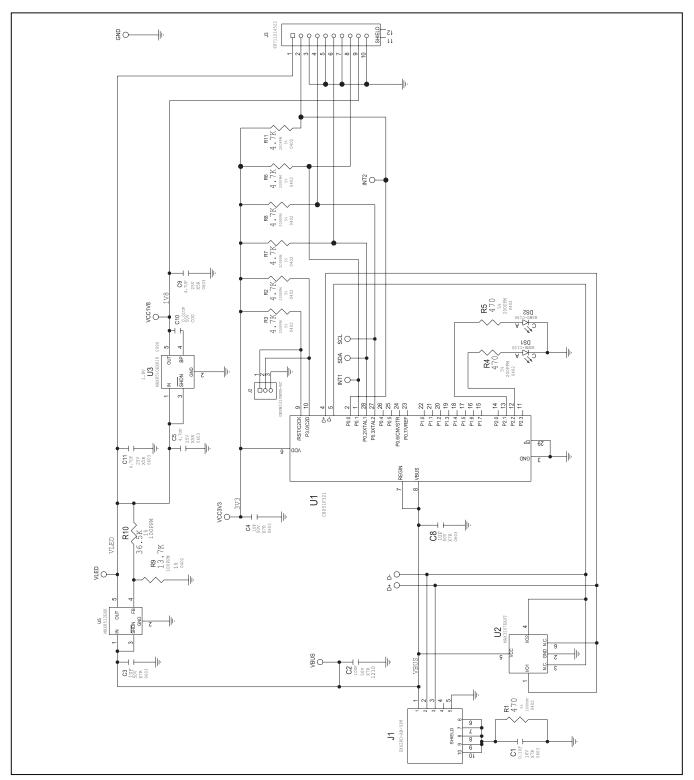
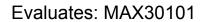


Figure 13. USBOSMB Mother Board Schematic



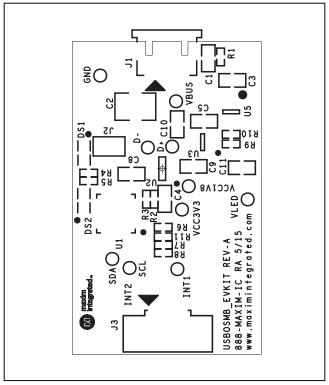


Figure 14. USBOSMB Mother Board Component Placement Guide—Component Side

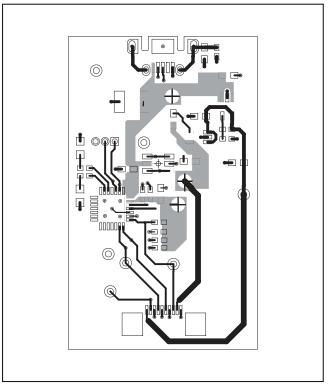


Figure 15. USBOSMB Mother Board PCB Layout—Component Side

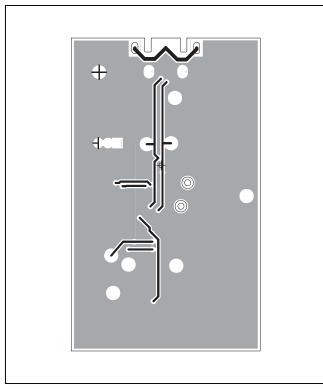


Figure 16. USBOSMB Mother Board PCB Layout—Solder Side

# **Component Lists**

### **MAX30101 Accelerometer EV Kit**

PART	QTY	DESCRIPTION
MAX30101DBEVKIT#	1	MAX30101 Daughter Board
USBOSMB#	1	Serial Interface Mother Board

Evaluates: MAX30101

# **Component List**

See the following link for component information:

- MAX30101 DB EV BOM
- MAX30101 USBOSMB EV BOM

# **Ordering Information**

PART	TYPE	LED
MAX30101ACCEVKIT#	EV Kit	IR, RED

#Denotes RoHS compliant.

# MAX30101 Evaluation System

# **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	5/16	Initial Release	_

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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Evaluates: MAX30101

DESIGN: max30101 db evkit a QTY VALUE ITEM REF DES MFG PART # MANUFACTURER DESCRIPTION 1 C6 TDK 10UF CAPACITOR; SMT (0603); CERAMIC CHIP; 10UF; 10V; TOL=10%; MODEL=; TG=-55 C1608X5R1A106K 2 2 C7. C16 C1608X5R1E106M080AC; CL10A106MA8NRNC TDK/SAMSUNG ELECTRONICS 10LIF CAPACITOR; SMT (0603); CERAMIC CHIP; 10UF; 25V; TOL=20%; TG=-55 DEGC TO 1 C12 C1608C0G1H103J; CGA3E2C0G1H103J080AD TDK 0.01UF CAPACITOR: SMT (0603): CERAMIC CHIP: 0.01UF: 50V: TOL=5%: MODEL=C1608 1 C13 TAIYO YUDEN 1UF CAPACITOR; SMT (0603); CERAMIC CHIP; 1UF; 50V; TOL=10%; TG=-55 DEGC TO UMK107AB7105KA 1 C14 C1608X5R1E475K080AC TDK 4.7UF CAPACITOR: SMT (0603): CERAMIC CHIP: 4.7UF: 25V: TOL=10%: MODEL=C 1 C15 KEMET 0.1UF CAPACITOR; SMT (0603); CERAMIC CHIP; 0.1UF; 16V; TOL=10%; TG=-55 DEGC TO C0603C104K4RACAUTO 0 DS1, DS4, DSMT660N DIODE: LED: HIGH PERFORMANCE TOP LED: RED: SMT: VF=2V: IF=0.02A **FPITEX** SMT660N **FPITFX** SMT880 0 DS2, DS5, ESMT880 DIODE; LED; HIGH PERFORMANCE TOP IR LED; INFRARED; SMT; VF=1.45V; 9 0 DS3, DS6, ESMT525 **FPITFX** SMT525 DIODE: LED: HIGH PERFORMANCE TOP LED: GREEN: SMT: VF=3.2V: IF=0.02A WURTH ELECTRONICS INC. 68711014522 CONNECTOR; FEMALE; SMT; 0.5MM ZIF HORIZONTAL BOTTOM CONTACT WR-

10 68711014522 1 J1 11 0 R1 RC0805JR-070RL 12 13 1 U4 MAX30102EFD+

PACKOUT (These are DO NOT INSTALL parts and will be shipped with PCB)

REF DES MFG PART #

1 PACKOUT 88-00713-LRG

1 PACKOUT 87-02162-00

3 PACKOUT EVINSERT

3 PACKOUT 85-MAXKIT-PNK

3 PACKOUT 85-84003-006 1 PACKOUT 88-00712-MDM

1 PACKOUT 87-02159-000

1 PACKOUT 88-00711-SML

1 PACKOUT 87-02163-000

TITLE: Bill of Materials DATE: 07/17/2015, Rev 0

14

15

16

QTY

TOTAL

ITEM

TOTAL

1 U6

1 U7

1

25

15

3 R2, R12, R1CRCW06030000ZS; MCR03EZPJ000; ERJ-3GEY0R00 LIS2DH MAX8510FXK33+ MAXIM **EPCB FPCR** 

YAGEO PHYCOMP VISHAY DALE/ROHM/PANASONIC MAXIM ST MICROELECTRONICS

MANUFACTURER

N/A

N/A

N/A

N/A

N/A

N/A

N/A

N/A

N/A

LIS2DH MAX8510FXK33+ MAXIM VALUE

MAX30102EFD+ PCR

DESCRIPTION

LABEL(EV KIT BOX) - PACKOUT

BOX:+:LARGE BROWN 15 1/8" X 8 3/4" X 3"

WEB INSTRUCTIONS FOR MAXIM DATA SHEET

BOX;+;MEDIUM BROWN 9 3/8" X 7 1/4" X 2 1/2"

ESD BAG:+:BAG: STATIC SHIELD 5"X8":W/ESD LOGO

BOX;SMALL BROWN 9 3/16"X7"X1 1/4" - PACKOUT

ESD BAG:+:BAG: STATIC SHIELD ZIP 8"X10": W/ ESD LOGO

PINK FOAM:FOAM:ANTI-STATIC PE 12inX12inX5MM - PACKOUT

RESISTOR: 0805: 0 OHM: 5%: JUMPER: 0.125W: THICK FILM RESISTOR: 0603: 0 OHM: 0%: JUMPER: 0.10W: THICK FILM

IC; SNSR; PULSE OXIMETER; HEART RATE AND UV SENSOR MODULE FOR MOBILE IC: MEMS: MEMS DIGITAL OUTPUT MOTION SENSOR: ULTRA LOW-POWER HIGH

IC; VREG; ULTRA-LOW-NOISE; HIGH PSRR; LOW-DROPOUT; 0.12A LINEAR

ESD BAG; BAG; STATIC SHIELD ZIP 4inX6in; W/ESD LOGO - PACKOUT

TITLE: Bill of Materials DATE: 03/27/2015, Rev 0 DESIGN: usbosmb evkit a ITEM OTY REF DES MFG PART MANUFACTURER VALUE DESCRIPTION STATUS CAPACITOR: SMT (0603): CERAMIC CHIP: 0.1UF: 16V: TOL=10%: TG=-1 1 C1 C0603C104KEMET 0.1UF 55 DEGC TO +125 DEGC: TC=X7R AUTO EVKIT-NOT FOR TEST CAPACITOR: SMT (1210): CERAMIC CHIP: 10UF: 50V: TOL=10%: TG=-2 1 C2 GRM32ER7 MURATA: SAMSUNG ELECTRONICS 10UF 55 DEGC TO +125 DEGC; TC=X7R ACTIVE CAPACITOR; SMT (0603); CERAMIC CHIP; 1UF; 50V; TOL=10%; TG=-3 1UF 55 DEGC TO +125 DEGC; TC=X7R 3 C3, C4, C8 UMK107AETAIYO YUDEN ACTIVE CAPACITOR: SMT (0603): CERAMIC CHIP: 4.7UF: 25V: TOL=10%: 4 3 C5, C9, C11C1608X5R1TDK 4.7UF MODEL=C SERIES; TG=-55 DEGC TO +85 DEGC; TC=X5R ACTIVE CAPACITOR; SMT (0603); CERAMIC CHIP; 0.01UF; 50V; TOL=5%; TG=-5 1 C10 0.01UF 55 DEGC to +125 DEGC: TC=C0G ACTIVE C1608C0G1TDK; MURATA DIODE: LED: SURFACE MOUNT CHIP LED: RED: SMT (0603): PIV=1.8V: 6 1 DS1 HSMH-C19 AVAGO TECHNOLOGIES HSMH-C190 IF=0.02A EVKIT-NOT FOR TEST DIODE; LED; SURFACE MOUNT CHIP LED; GREEN; SMT (0603); 7 1 DS2 HSMG-C19 AVAGO TECHNOLOGIES HSMG-C190 PIV=2.2V; IF=0.02A EVKIT-NOT FOR TEST CONNECTOR; MALE; SMT; MICRO-USB CONNECTOR MEETING 8 1 11 ZX62RD-AEHIROSE ELECTRIC CO LTD. ZX62RD-AB-5P8 REQUIREMENTS OF USB 2.0 STANDARD; RIGHT ANGLE; 5PINS ACTIVE OT FOR TEST OT FOR TEST OT FOR TEST OT FOR TEST OT FOR TEST

				CONNECTOR; MALE; THROUGH HOLE; 0.050 SINGLE ROW MALE	
9	1 J2	GRPB031V'SULLINS ELECTRONICS CORP.	GRPB031VWVN-RC	HEADER CONNECTOR; STRAIGHT; 3PINS; -40 DEGC TO +105 DEGC	EVKIT-NOT
				CONNECTOR; FEMALE; SMT; 0.5MM ZIF HORIZONTAL BOTTOM	
10	1 J3	6.87E+10 WURTH ELECTRONICS INC.	68711014522	CONTACT WR-FPC; RIGHT ANGLE; 10PINS	EVKIT-NOT
11	3 R1, R4, R5	5 ERJ-2GEJ47PANASONIC	470	RESISTOR; 0402; 470 OHM; 5%; 200PPM; 0.10W; THICK FILM	EVKIT-NOT
12	6 R2, R3, R6	5- ERJ-2GEJ47PANASONIC	4.7K	RESISTOR; 0402; 4.7K OHM; 5%; 200PPM; 0.10W; THICK FILM	EVKIT-NOT
13	1 R9	CRCW0402 VISHAY DALE	13.7K	RESISTOR; 0402; 13.7K OHM; 1%; 100PPM; 0.063W; THICK FILM	ACTIVE
14	1 R10	CRCW0402 PANASONIC	36.5K	RESISTOR; 0402; 36.5K OHM; 1%; 100PPM; 0.063W; THICK FILM	EVKIT-NOT
15	1 111	C8051E321SILICON LABORATORIES	C8051F321	IC: CTRI: FULL SPEED USB 16K ISP FLASH MCU FAMILY: OFN28-FP	FVKIT-NOT

EVKIT-NOT FOR TEST IC; PROT; DUAL, QUAD, AND HEX HIGH-SPEED DIFFERENTIAL ESD-1 U2 MAX3207E MAXIM PROTECTION IC; SOT23-6 16 MAX3207EAUT ACTIVE

IC; VREG; ULTRA-LOW-NOISE; HIGH PSRR; LOW-DROPOUT; 0.12A 17 1 U3 MAX8510E MAXIM MAX8510FXK18 LINEAR REGULATOR: SC70-5 ACTIVE

MAX8512EXK

MAXIM

PCB

WR FFC 0.50mm TYPE 1 CABLE

IC, VREG, Ultra-Low-Noise, High PSRR, Adjustable Vout, SC70-5

ACTIVE

PCB: MAX

18

19

TOTAL PACK OUT 1

1 U5

1

30

1

MAX8512E MAXIM

**EPCB** 

MAX

6.88E+11 WURTH ELECTRONICS INC.